# Communication Protocols

Notes and/or Reference

## Huge Amount of Self-Contained Devices

- Sensors
- A-to-D converters
- D-to-A
- Memory
- Microcontrollers
- Etc...

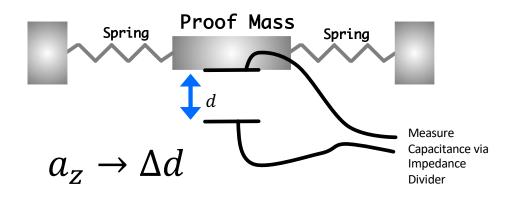
 We need ability/fluency to extract info from and work with them

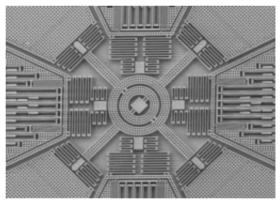
#### Case Study

- 9 axis IMU (Inertial Measurement Unit)
  - Accelerometer
  - Gyroscope
  - Magnetometer
- One of the only real MEMS
   (MicroElectroMechanical Systems) applications that has gone full-scale (others might be TI's DMD, gyroscopes, microphones, some microfluidics, Si resonators, Piezoelectrics from Inkjets, etc...)

#### Accelerometers

- First MEMS accelerometer: 1979
- Position of a proof mass is capacitively sensed and decoded to provide acceleration data





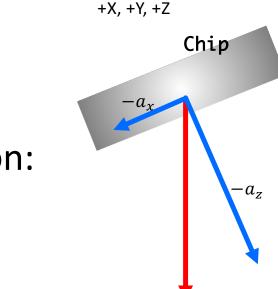
SEM of two-axis accelerometer

#### Uses of Acceleration Measurements:

- Acceleration can be used to detect motion
  - (pedometer, free-fall/drop detection):

$$a_T = \sqrt{a_x^2 + a_y^2 + a_z^2}$$
$$\theta_y = \tan^{-1}\left(\frac{a_z}{a_x}\right)$$

Use gravity and trig to find orientation:



Accelerometer directions

#### **Problems**

- Accelerometers have huge amounts of highfrequency noise
- To fix, usually Low Pass Filter the raw signal (Infinite Impulse Response approach shown below)
- This cuts down on frequency response though 😊

$$\theta_y[n] = \theta_y[n-1]\beta + (1-\beta)\tan^{-1}\left(\frac{a_z[n-1]}{a_x[n-1]}\right)$$

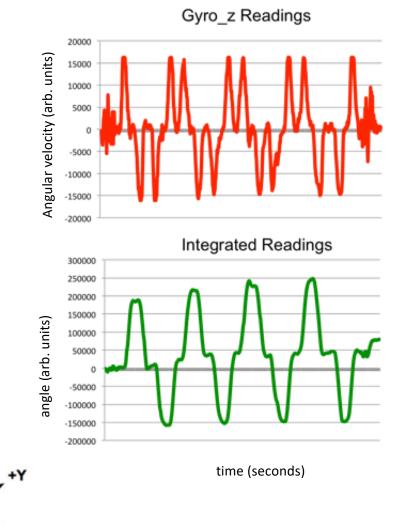
 $a_{
m c}$  X acceleration 0<eta<1 Filter Coefficient

 $a_z$  z acceleration  $heta_v$  Angle estimate around y axis

### Bring in Gyroscopes

- Provide Direct Angular
   Velocity which we can integrate to get angle
- Very little high-frequency noise, but lots of low frequency noise (Gyros drift like crazy

Gyro readings are "around" the axis they refer to (use righthand rule):

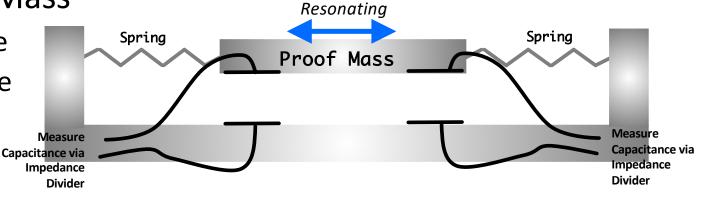


### Gyro Operation

Resonating Proof Mass

Electrostatic Drive

Piezoelectric Drive



Resonating

**Proof Mass** 

Turning out-of-plane:

Proof-mass fights the <u>turn</u>

 Detect deviation via capacitance

Do this for all three axes

Changes in capacitance measured at different points

Scale not accurate/nor design details

Measure Capacitance via Impedance Divider

Measure Capacitance via Impedance

Divider

Rotation of Device

Spring

### How to use Gyro Readings:

- Because of Drift (low frequency noise/offset) you want to avoid doing much long-term integration with a gyro reading
- Having beta less than unity ensures any angle that comes from gyro reading will eventually disappear, but in short term it will dominate
- Depending on time step:  $\theta_g[n] = \beta \theta_g[n-1] + Tg_y[n-1]$

$$0 Filter Coefficient  $g_{\mathcal{Y}}$  Gyro y reading  $etapprox 0.95$  starting point  $T$  Time Step$$

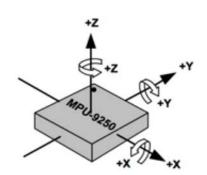
#### What to do?

 Using only accelerometer, leaves us blind to motion/change in the short term but fine in the long-term

 Using only gyroscope, leaves us blind in the long term, but good in the short term

What to do?

## Merge the signals



#### Complementary Filter:

$$\theta_{y}[n] = \beta \left(\theta_{y}[n-1] + Tg_{y}[n-1]\right) + (1-\beta) \tan^{-1} \left(\frac{a_{z}[n-1]}{a_{x}[n-1]}\right)$$

$$0 Filter Coefficient  $g_y$  Gyro y reading  $a_\chi$  X acceleration  $a_\chi$  Time Step.  $\betapprox 0.95$  good starting point  $a_Z$  z acceleration$$

 Very simple form of <u>sensor fusion</u> (where you merge data from more than one sensor to build up model of what is going on)

#### Sensor Fusion

- Most modern sensors are used with other sensors:
  - Accelerometers with gyroscopes for quick relative orientation detection
  - GPS with magnetic field with local WiFi sniffing for absolute location determination
  - Fuse multiple microphones together for user voice
  - Many others...
- Can be incorporated open-loop (like complementary filter on previous page)
- Or incorporate into "learning" algorithms:
  - NLMS, Kalman, LQE, Baysean, Linear-Observer System
  - Estimate, compare to new data, correct, repeat...

## How to get Access to the signals in first place?

- Some accelerometers are analog out (can therefore read them with an A-to-D converter) (ADXL335, for example)
- These have limited functionality...and also it is analog so there's the whole noise issue....which is not nice
- Most flavors of sensors are digital

#### MPU-9250

Board: \$5.00 from Ebay

Chip: \$3.00 in bulk

- Use in Lab 5
- 3-axis Accelerometer (16-bit readings)
- 3-axis Gyroscope (16-bit readings)
- 3-axis Magnetic Hall Effect Sensor (Compass) (16 bit readings)
- SPI or I2C communication (!)...no analog out
- On-chip Filters (programmable)
- On-chip programmable offsets
- On-chip programmable scale!
- On-chip sensor fusion possible (with quaternion output)!
- Interrupt-out (for low-power applications!)
- On-chip sensor fusion and other calculations (can do orientation math on-chip or pedometry even)
- So cheap they usually aren't even counterfeited! ©

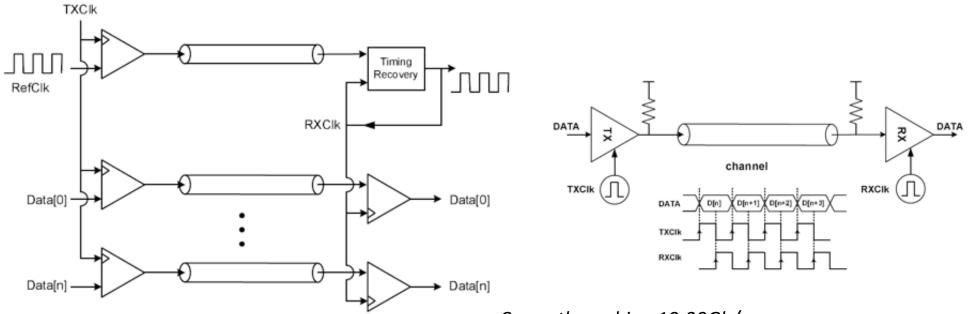
## Common Chip-Chip Communication Protocols

- Parallel (not so much anymore)...mostly memory and things that need to send data at very high rates such as a camera
- Serial (UART) (still common in some communication and GPS devices)
- SPI (Serial Peripheral Interface) very common
- I2C (Inter-Integrated Circuit Communication) very common
- I2S (Inter-Integrated Circuit Sound Bus) very common

## Serial and Parallel at High Level

#### Parallel Link:

#### **Serial Link:**



Currently pushing 10-30Gb/s ...

#### Serial Communications

- Sending information one bit at a time vs. many bits in parallel
  - Serial: good for long distance (save on cable, pin and connector cost, easy synchronization). Requires "serializer" at sender, "deserializer" at receiver
  - Parallel: issues with clock skew, crosstalk, interconnect density, pin count. Used to dominate for short-distances (eg, between chips).
  - BUT modern preference is for parallel, but independent serial links (eg, PCI-Express x1,x2,x4,x8,x16) as a hedge against link failures.

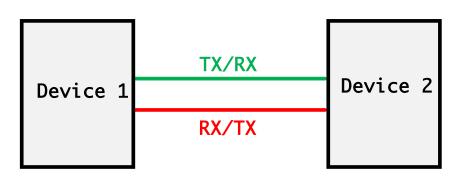
#### A zillion standards

- Asynchronous (no explicit clock) vs. Synchronous (CLK line in addition to DATA line).
- Recent trend to reduce signaling voltages: save power, reduce transition times
- Control/low-bandwidth Interfaces: SPI, I<sup>2</sup>C, 1-Wire, PS/2, AC97
- Networking: RS232, Ethernet, T1, Sonet
- Computer Peripherals: USB, FireWire, Fiber Channel, Infiniband, SATA, Serial Attached SCSI

## Common Chip-Chip Communication Protocols

- Parallel (not so much anymore).
- Serial (UART) (still common in some classes of devices)
- SPI (Serial Peripheral Interface) very common
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- I2S (Inter-Integrated Circuit Sound Bus) very common

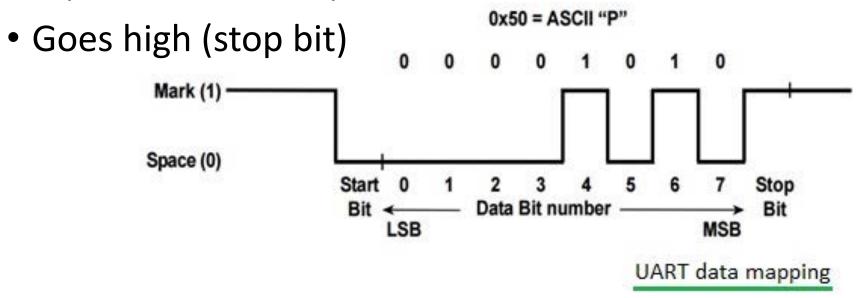
## Serial (UART)



- Stands for Universal Asynchronous Receiver Transmitter
- Requires agreement ahead-of-time between devices regarding things like clock rate (BAUD), etc...
- Two wire communication
- Cannot really share
  - (every pair of devices needs own pair of lines)
- Data rate really < 115.2Kbps</li>
- Data sent LSB first

## Serial (UART)

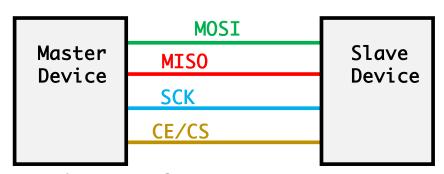
- Line Hi at rest
- Drops Low to indicate start
- 8 (or 9 bits follows)



### Note on Terminology

- In device-to-device communication, it is common to have one device labeled the "Master" and one labeled the "Slave"...the Master controls the Slave(s) in these settings.
- Trace history of this naming terminology back to 1940s
- I've seen some alternatives suggested: Leader/Follower,
   Primary/Secondary (other ideas?), but this naming scheme persists in the field and on data sheets
- Movement from this terminology has occurred more readily in software than hardware...Django has transitioned
- Los Angeles actually requested manufacturers to use alternative naming scheme as far back as 2003

#### SPI



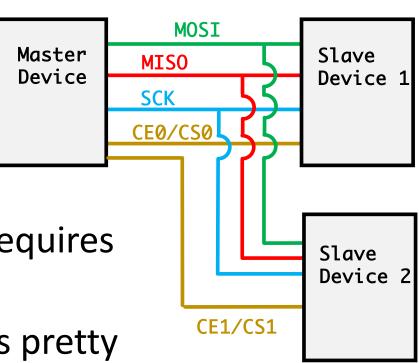
- Stands for Serial-Peripheral Interface
- Four Wires:
  - MOSI: Master-Out-Slave-In
  - MISO: Master-In-Slave-Out
  - SCK: Serial Clock
  - CE/CS (Chip Enable or Chip Select)
- SCK removes need to agree ahead of time on data rate (from UART)
- High Data Rates: (1MHz up to ~70 MHz clock (bits))
- Data MSB or LSB first...up to devices

#### SPI

Can share MOSI/MISO Bus

 Addition of multiple slaves requires additional select wires

- Hardware/firmware for SPI is pretty easy to implement:
  - Wires are uni-directional
  - Classic "duh" sort of approach to digital communication, but very robust.



### SPI Example

MCP3008 is a 8-channel 10 bit ADC from Microchip that communicates over SPI



#### 

From MCP3008 Datasheet

 After completing the data transfer, if further clocks are applied with CS low, the A/D converter will output LSB first data, then followed with zeros indefinitely. See Figure 5-2 below.

Here I am talking to a MCP3008 10 bit ADC

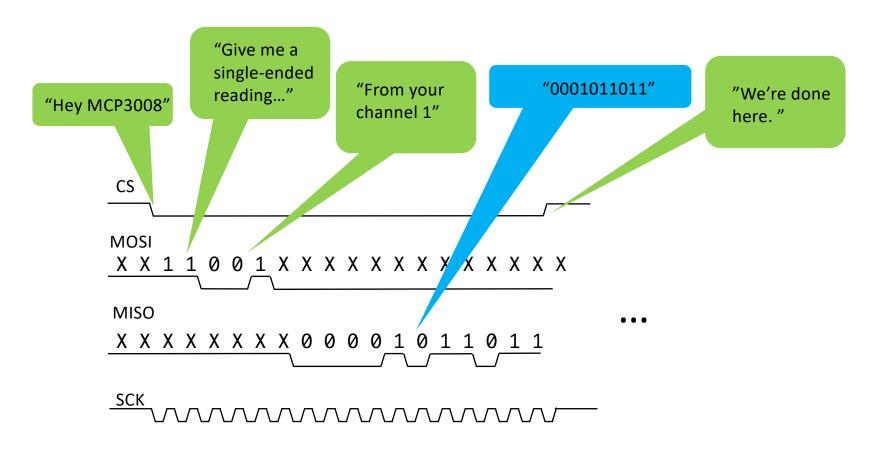
Sends its data MSB first

**TOATA** 

• • •

<sup>\*\*</sup> t<sub>DATA</sub>; during this time, the bias current and the comparator powers down while the reference input becomes a high-impedance node.

### SPI Example

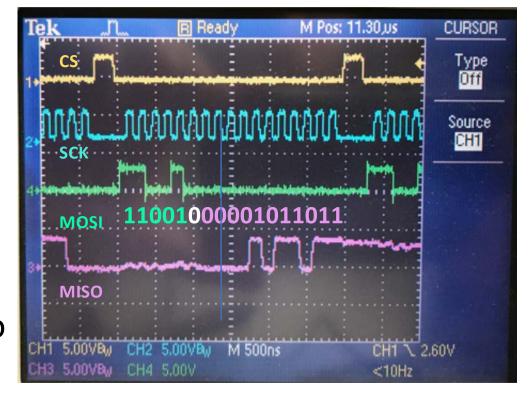


Artix-7 (Master Device) Dialog MCP3008 (Slave Device) Dialog

X means don't care

#### SPI In Real Life

- Here I am talking to the same chip I was daydreaming about talking to on the previous slide.
- Dreams do come true
- I'm saying, "give me your measurement on Channel 1," and it is responding with "10'b0001011011" mapped to 3.3V or 0.293 V





#### Six Wires:

MOSI: Master-Out-Slave-In

MISO: Master-In-Slave-Out

• SCK: Clock

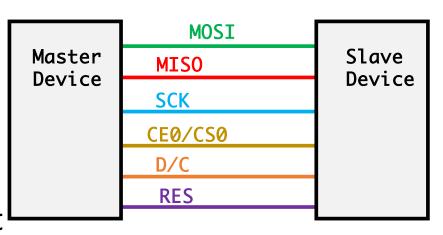
CE/CS (Chip Enable or Chip Select)

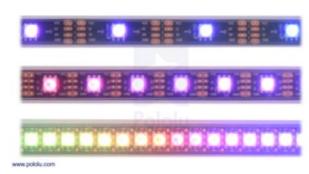
RES: Reset Device

 D/C: Data/Command (often seen in devices where you need to write tons of data (i.e. a display)

#### Three/Two Wires:

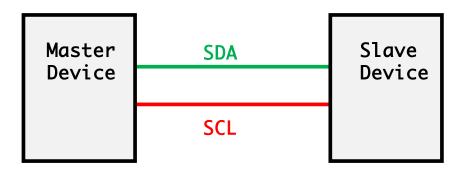
- If a device has nothing to say, drop MISO:
- If you assume only one device on bus drop CE/CS





#### 12C

- Stands for Inter-Integrated Circuit communication
- Invented in 1980s
- Two Wire, One for Clock, one for data (both directions)
- Usually 100kHz or 400 kHz clock (newer versions go to 3.4 MHz)



## On i2C Multiple Devices Require Same # of Wires \_\_\_\_\_

 Devices come with their own ID numbers (originally a 7 bit value but more modern ones have 10 bits)...allows potentially up to 2^7 devices or 2^10 on a bus (theoretically anyways)

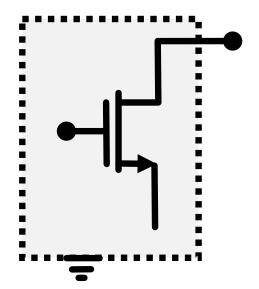
Master Device SDA Slave Device 1

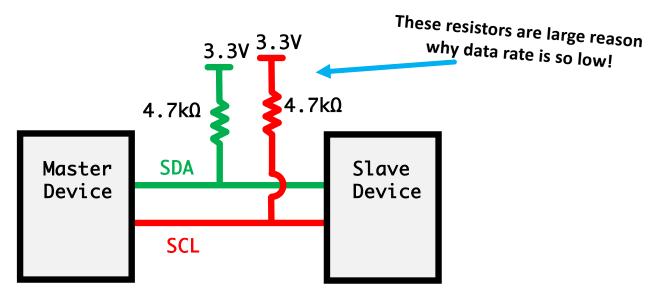
SCL Slave Device 2

 ID's are specified at the factory, usually several to choose from when you implement and you select them by pulling external pins HI or LOW

#### More to story (need pull-up resistors)

- i2C uses an open drain
- Meaning both Master and Slave Device are either:
  - LOW
  - High-Impedance
- Need external pull-up resistors





#### Tri-State

 inout cannot be a reg ever, ever...it is closer to a wire...usual way to work with them is the following:

In verilog...

```
inout sda;
reg sda_val;
assign sda = sda_val? 1'bz: 1'b0;
```

#### As a result:

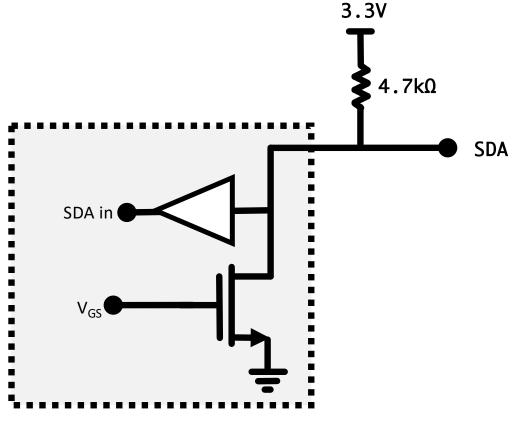
```
inout sda;
reg sda_val;
assign sda = sda_val? 1'bz: 1'b0;
```

#### Wanna write to SDA?

```
sda_val <= 0; //or 1 if desired :wq</pre>
```

#### Wanna read to SDA?

```
sda_val <= 1;
//wait clock cycle...
some_reg <= sda; //read from input</pre>
```

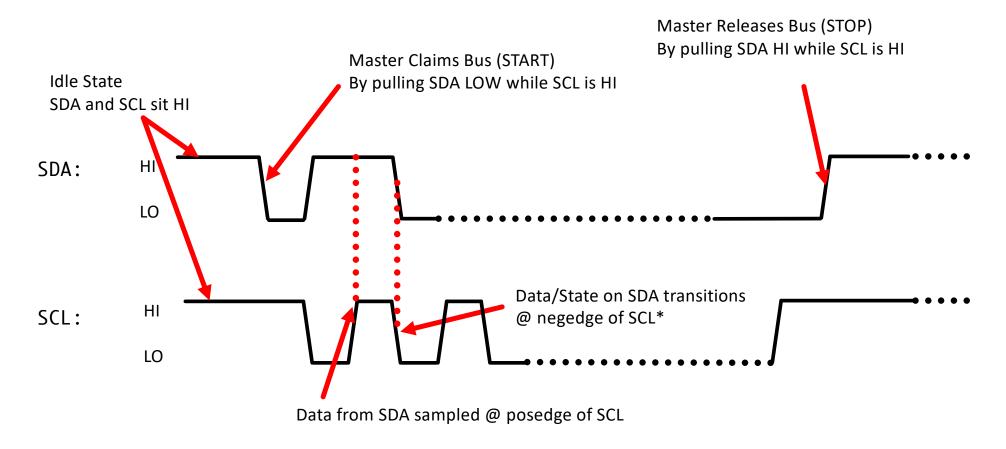


Mode	Master	Slave
Master Transmit	HiZ (HI) or LOW	HiZ (listening)
Slave ACK/NACK	HiZ (listening)	HiZ (HI) or LOW
Slave Transmit	HiZ (listening)	HiZ (HI) or LOW
Master ACK/NACK	HiZ (HI) or LOW	HiZ (listening)

### i2C Operation

- Data is conveyed on SDA (Either from Master or Slave depending on point during communication)
- SCL is 50% duty cycle
- SDA generally changes on falling edge of SCL (isn't required)
- SDA sampled at rising edge of SCL
- Master is in charge of setting SCL frequency and driving it
- Data is sent MSB first

### Meanings I: (Start, Stop, Sampling)



\*not specified but probably easiest spot to do

### Meanings II Address

 First thing sent by Master is 7 bit address (10 bit in more modern i2C...has some leading 11111's in it..don't worry about that)

 If a device on the bus possesses that address, it acknowledges (ACK/NACK=0) and it becomes the slave

 All other devices (other than Master/Slave Devices) will ignore until STOP signal appears later on.

## Meanings III (Read/Write Bit)

- After sending address, a Read/Write Bit is specified by Master on SDA:
  - If Write (0) is specified, the next byte will be a register to write to, and following bytes will be information to write into that register
  - If Read (1) is specified, the Slave will start sending data out, with the Master acknowledging after every byte (until it wants data to not be sent anymore)

## Meanings IV (ACK/NACK)

- After every 8 bits, it is the listener's job to acknowledge or not acknowledge the data just sent (called an ACK/NACK)
- Transmitter pulls SDA HI and listens for next reading (@posedge of SCL):
  - If LOW, then receiver acknowledges data
  - If remains HI, no acknowledgement
- Transmitter/Receiver act accordingly

### Meanings V

- For Master Device to write to Slave Device:
  - START
  - Send Device Address (with Write bit)
  - Send register you want to write to
  - Send data...until you're satisfied
  - STOP
- For Master Device to read from Slave Device:
  - START
  - Send Device Address (with Write bit)
  - Send register you want to read from
  - ReSTART communication
  - Send Device Address (With Read bit)
  - Read the bits
  - After every 8 bits, it is Master's job to acknowledge Slave...continued acknowledgement leads to continued data out by Slave.
  - Not-Acknowledge says "no more data from Slave"
  - STOP leads to Master ceasing all communication

## Implementing i2C on FPGA with MPU9250:

- Made master i2C controller in Verilog
- Used MPU9250 Data sheet: 42 pages (basic functionality, timing requirements, etc...)
- MPU9250 Register Map: 55 pages

Addr (Hex)	Addr (Dec.)	Register Name	Serial I/F		
35	53	I2C_SLV4_DI	R		
36	54	I2C_MST_STATUS	R		
37	55	INT_PIN_CFG	RW		
38	56	INT_ENABLE	R/W		
за	58	INT_STATUS	R		
38	59	ACCEL_XOUT_H	R		
3C	60	ACCEL_XOUT_L	R		
3D	61	ACCEL_YOUT_H	R		
3E	62	ACCEL_YOUT_L	R		
3F	63	ACCEL_ZOUT_H	R		
40	64	ACCEL_ZOUT_L	R		
41	65	TEMP_OUT_H	R		
42	66	TEMP_OUT_L	R		
43	67	GYRO_XOUT_H	R		
44	68	GYRO_XOUT_L	R		
45	69	GYRO_YOUT_H	R		
46	70	GYRO_YOUT_L	R		
47	71	GYRO_ZOUT_H	R		
48	72	GYRO_ZOUT_L	R		

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# State-Machine Implementation of i2C Master

- Continuously reads 2 bytes starting at the 0x3B register (X accelerometer data)
- Print out value in hex in LEDs
- 34 States
- Clocked at 200kHz, and creates 100 kHz SCL
- Change SDA on falling edge of SCL
- Sample SDA on rising edge of SCL

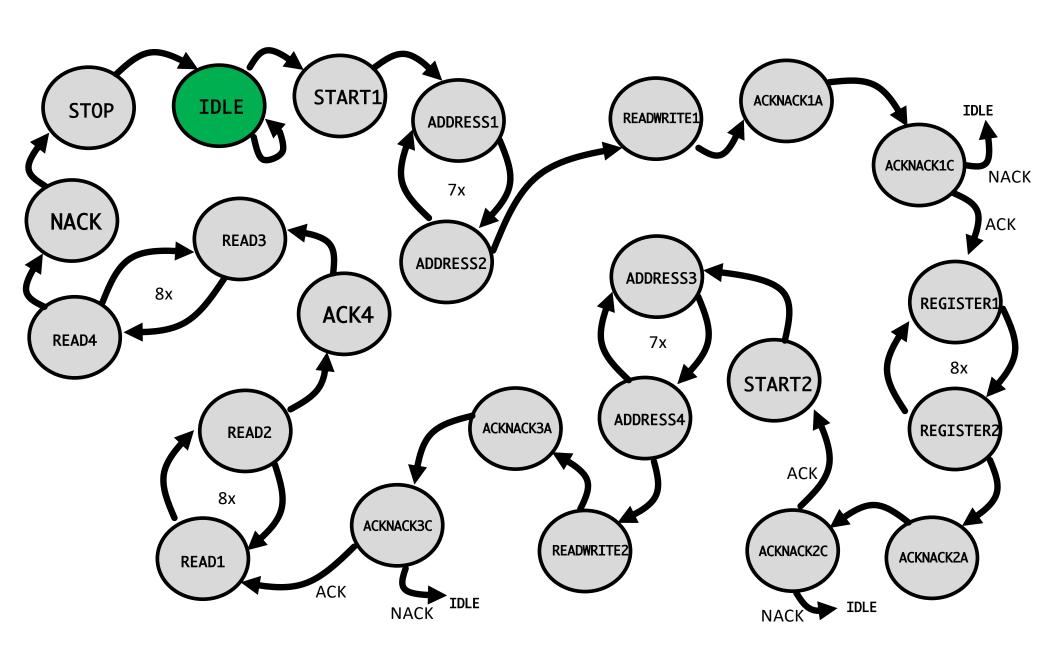
```
lule i2c master(input clock
 inout scl.
 output sys clock)
 localparam IDLE = 6'd0; //Idle/initial state (SDA= 1, SCL=1)
 localparam START1 = 6'd1; //FPGA claims bus by pulling SDA LOW while SCL is HI
 localparam ADDRESS1A = 6'd2; //send 7 bits of device address (7'h68)
 localparam ADDRESS1B = 6'd3; //send 7 bits of device address
 localparam READWRITE1A = 6'd4; //set read/write bit (write here) (a 0)
 localparam READWRITE1B = 6'd5; //set read/write bit (write here)
 localparam ACKNACK1A = 6'd6: //pull SDA HI while SCL ->LOW
 localparam ACKNACK1B = 6'd7; //pull SCL back HI
 localparam ACKNACK1C = 6'd8; //Is SDA LOW (slave Acknowledge)? if so, move on, else go back to IDLE
 localparam REGISTER1A = 6'd9; //write MPU9250 register we want to read from (8'h3b)
 localparam REGISTER1B = 6'd10; //write MPU9250 register we want to read from
 localparam ACKNACK2A = 6'd11; //pull SDA HI while SCL -> LOW
 localparam ACKNACK2B = 6'd12; //pull SCL back HI
 localparam ACKNACK2C = 6'd13; //ls SDA LOW (slave Ack?) If so move one, else go to idle
 localparam START2A = 6'd14; //SCL -> HI
 localparam START2B = 6'd15; //SDA -> HI
 localparam START2C = 6'd16; //SDA -> LOW (restarts)
 localparam ADDRESS2A = 6'd17; //Address again (7'h68)
 localparam READWRITE2A = 6'd19: //readwrite bit...this time read (1)
 localparam READWRITE2B = 6'd20: //readwrite bit...this time read (1)
 localparam ACKNACK3A = 6'd21; //like other acknacks...wait for MPU to respond
 localparam ACKNACK3B = 6'd22; //else go back to IDLE
 localparam ACKNACK3C = 6'd23; //""""
 localparam READIA = 6'd24; //start reading in data from device
 localparam READ1B = 6'd25; //this data is 8MSB of x accelerometer reading
 localparam READ2A = 6'd28; //start reading next 8 bits (8LSB)
 localparam READ2B = 6'd29; //assign to lower half of 16 bit register
 localparam NACK = 6'd30; //Fail to acknowledge Slave this time (way to say "I'm done so slave doesn'
 localparam STOP1A = 6'd31; //Stop/Release line
 localparam STOP1B = 6'd32; //FPGA master does this by pulling SCL HI while SDA LOW
 localparam STOP1C = 6'd33; //Then pulling SDA HI while SCL remains H
```

# State-Machine Implementation of i2C Master

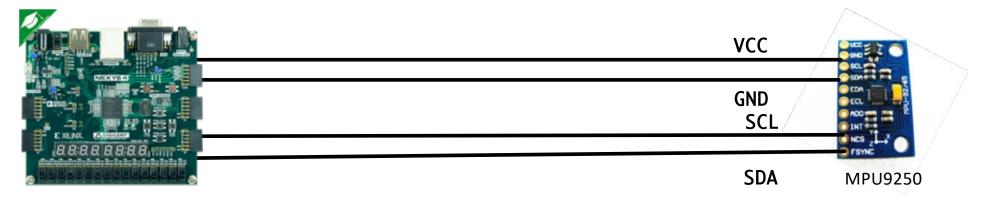
- Redundant states (repeated READ/WRITE, ADDRESS, ACK/NACK, etc...)
- ARM manual describes ~20 state FSM
- Included code on site for reference/starting point
- Diagram: on next page for reference

```
always @(posedge clock_for_sys)begin //update only on r
    if (reset &&(state !=IDLE))begin
   end else begin
                sda val <=1;
                    state <= READWRITE1A
                sda_val <=0;//write address
```

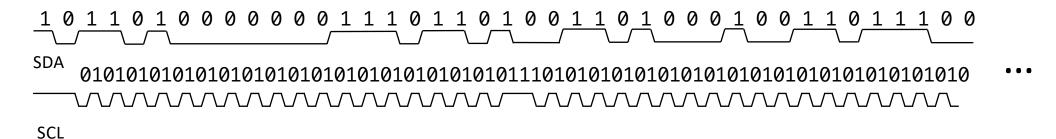
...200 more lines



#### Communication Part

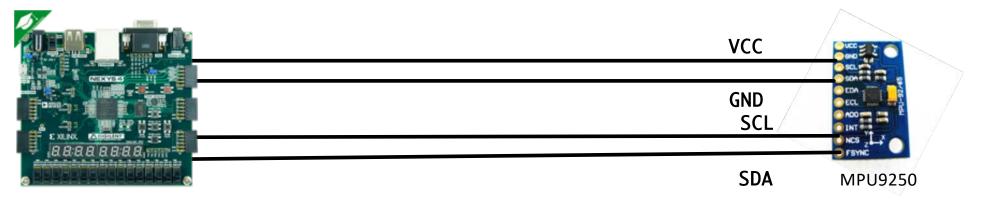


Nexys4

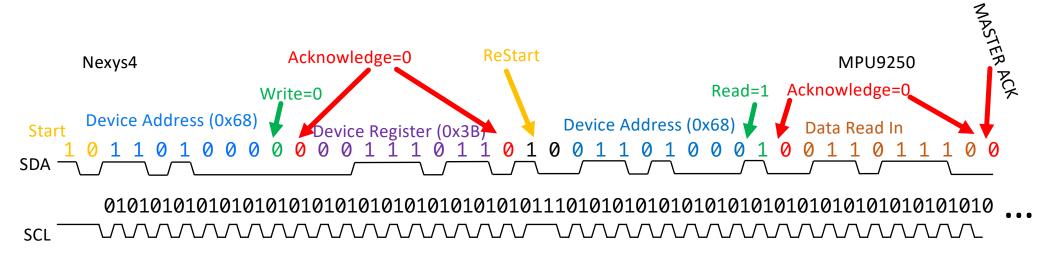


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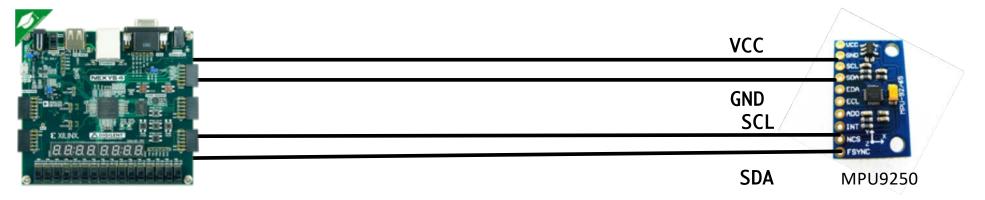
#### Communication Part



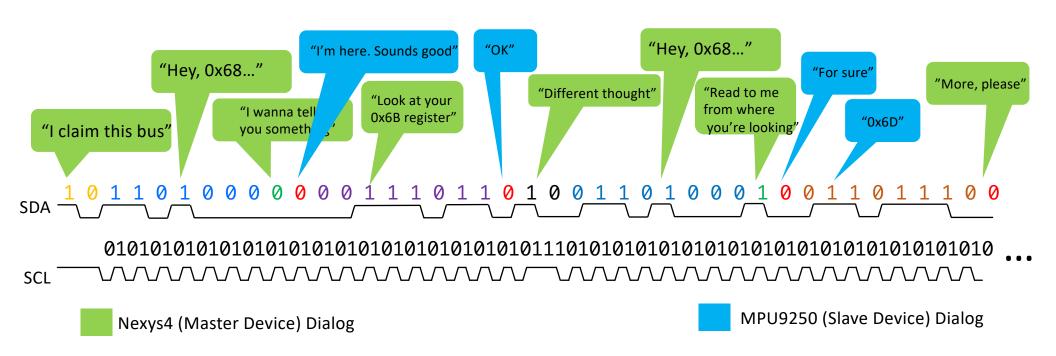
Nexys4



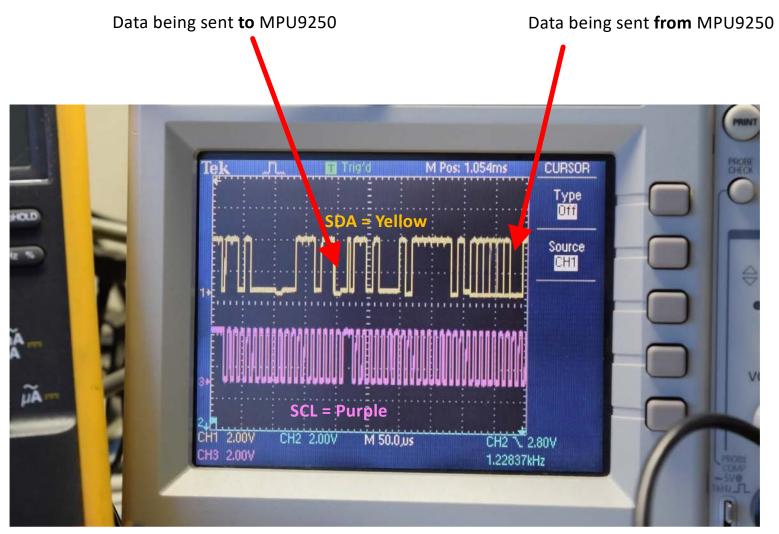
#### Communication Part



Nexys4

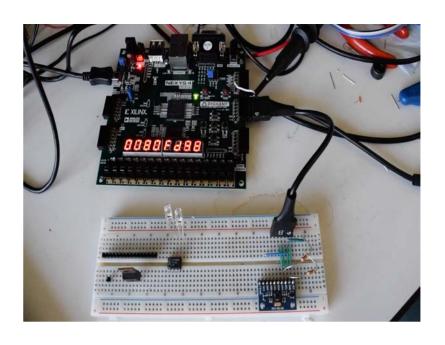


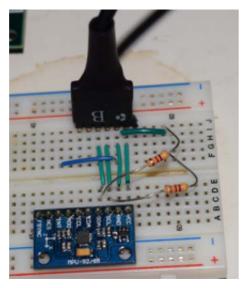
#### Communication in Real-Life:



Triggered on leaving IDLE state

### Running and reading X acceleration:





**HOOKUP** 

#### **Horizontal:**

16'hFD88 = 16'b1111\_1101\_1000\_1000 (2's complement) Flip bits to get magnitude: 16'b0000\_0010\_0111\_0111 =-315

Full-scale (default +/- 2g)

-315/(2\*\*15)\*2g = -0.02g © makes sense

#### **Vertical:**

16'h4088 = 16'b0100\_0000\_1000\_1000 (2's complement) Leave bits to get magnitude: 16'b0100\_0000\_1000\_1000 =+16520

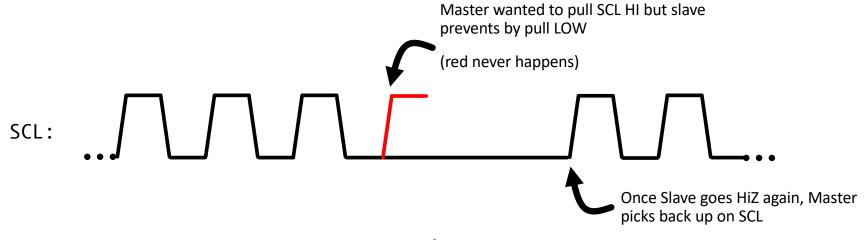
Full-scale (default +/- 2g)

-16520/(2\*\*15)\*2 = +1.01g © makes sense!

## Clock-Stretching (Cool part of i2C!!!)



 Normally Master drives SCL, but since Master drives SCL high by going hiZ, it leaves the option open for Slave to step in and prevent SCL from going high by pulling SCL LOW



 Allows Slave a way to buy time/slow down things (if it requires multiple clock cycles to process incoming data and/or generate output)

## 12s (Inter-IC Sound Bus)



- Not related to i2C at all
- Intended for Digitized Stereo Data
- Three Wires:
  - SDA: Serial Data (The actual music)
  - WS: Word Select (Left/Right Channel)
  - SCL: Serial Clock (For Synchronization)
- Push-Pull Driving (like SPI...no need for pull-up resistors)
- Data sent MSB first
- Clock-rate dictated by sample rate (44.1kHz @16 bits per channel /w 2 channels = ~1.4 MHz for example



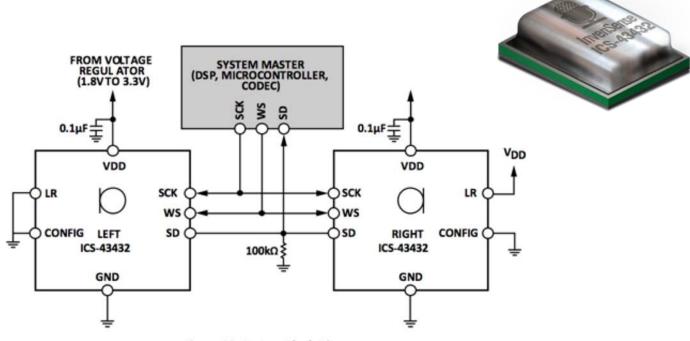


Figure 10. System Block Diagram

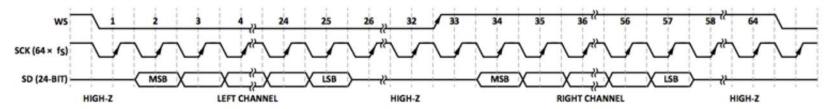


Figure 11. Stereo Output I2S Format

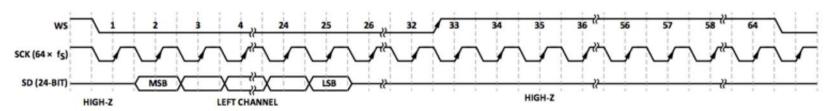


Figure 12. Mono Output I2S Format Left Channel (LR = 0)

## Implementation

- You've built a UART/serial module already...it was pretty short/easy
- Vivado has IP cores for i2C Master and i2S Masters
- SPI is much more open to interpretation and loose on its specs so no default core that I can find:
  - I put some generic skeleton code on github/site with a FIFO buffer that can get folks started if they need it.

## Compare and Contrast?

- Generally the fewer the wires the more rigid the protocol
- SPI can be very flexible and high speed (have only 10 bits to send? No problem...send 10!...can't do that do that with i2C...need to zero-pad up to the next full byte (16 bits)
- In terms of implementation, generally with communication protocols, the more wires, the easier the protocol/less overhead

#### Which to Choose?

- SPI is generally easier and more flexible to implement, but only certain devices use it since it takes up a lot of pins (and pins are expensive/limited)
- "Slow" and "Fast" data rates are relative too...i2C is not as much of a compromise now as it was fifteen years ago, particularly with high-speed i2C (or even now that 400 kHz rates are common)
- Remember, these are all meant for chip-to-chip communications!
- Check out the example i2C code from this lecture for the IMU, and a generic SPI master I wrote up as well...see if you can add clock-stretching! (not required)

### Going Between boards

- Previous protocols are meant for device-to-device communication
- There is no cabling standard for these protocols
- Distances are not specified for i2C, SPI, i2S, but think in terms of inches
- Open-Drain protocols are particularly susceptible to parasitics so keep leads short where possible!
- To go between devices we must use other protocols!

## RS232 (aka "serial port")

- Labkit: simple bidirectional data connection with computer.
- Characteristics
  - Large voltages => special interface chips (1/mark: -12V to -3V, 0/space: 3V to 12V)
  - Separate xmit and rcv wires: full duplex
  - Slow transmission rates (1 bit time = 1 baud); most interfaces support standardized baud rates: 1200, 2400, 4800, 9600, 19.2K, 38.4K, 57.6K, 115.2K
  - Format
    - Wire is held at 1/mark when idle
    - Start bit (1 bit of "0" at start of transmission)
    - Data bits (LSB first, can be 5 to 8 bits of data)
    - Parity bit (none, even, odd)
    - Stop bits (1, 1.5 or 2 bits of 1/mark at end of symbol)
    - Most common 8-N-1: eight data bits, no parity, one stop bit

#### RS232 interface

 Transmit: easy, just build FSM to generate desired waveform with correct bit timing

#### Receive:

- Want to sample value in middle of each bit time
- Oversample, eg, at 16x baud rate
- Look for 1->0 transition at beginning of start bit
- Count to 8 to sample start bit, then repeatedly count to 16 to sample other bits
- Check format (start, data, parity, stop) before accepting data.

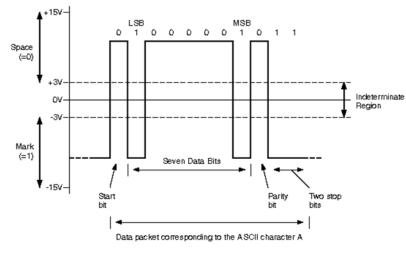


Figure from http://www.arcelect.com/rs232.htm

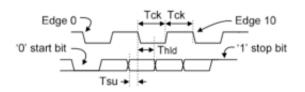
Should look familiar from Lab 2!

## PS/2 Keyboard/Mouse Interface

 2-wire interface (CLK, DATA), bidirectional transmission of serial data at 10-16kHz

#### Format

- Device generates CLK, but host can request-to-send by holding CLK low for 100us
- DATA and CLK idle at "1", CLK starts when there's a transmission. DATA changes on CLK, sampled on CLK
- 11-bit packets: one start bit of "0", 8 data bits (LSB first), odd parity bit, one stop bit of "1".
- Keyboards send scan codes (not ASCII!) for each press, 8'hF0 followed by scan code for each release
- Mice send button status, Δx and Δy of movement since last transmission

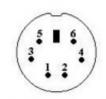


Symbol	Parameter	Min	Max
1,000		30us	50us
T <sub>SU</sub>	Data-to-clock setup time	5us	25us
T <sub>HLD</sub>	Clock-to-data hold time	5us	25us

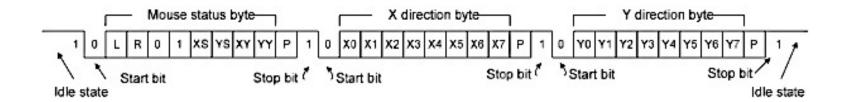
Figures from digilentinc.com

## PS/2 Keyboard/Mouse Interface

 2 signal wire interface (CLK, DATA), bidirectional transmission of serial data at 10-16kHz



Pin	Signal	In/Out
1	Data	Out
2	N/C	
3	Ground	
4	+5V	
5	Clock	Out
6	N/C	



Figures from digilentinc.com

## IDE Bus – Serial ATA (SATA)

#### 40-Pin IDE Connector PinOut

Pin#	Signal Function	Pin#	Signal Function		
1	Reset	2	Ground		
3	Data 7	4	Data 8		
5	Data 6	6	Data 9		
7	Data 5	8	Data 10		
9	Data 4	10	Data 11		
11	Data 3	12	Data 12		
13	Data 2	14	Data 13		
15	Data 1	16	Data 14		
17	Data 0	18	Data 15		
19	Ground	20	Key		
21	DMARQ	22	Ground		
23	DIOW-	24	Ground		
25	DIOR-	26	Ground		
27	IORDY	28	CSEL		
29	DMARK-	30	Ground		
31	INTRQ	32	IOCS16-		
33	DA1	34	PDIAG-		
35	DA0	36	DA2		
37	CS1FX-	38	CS3FX-		
39	DASP-	40	Ground		

#### **SATA**

Pin	Name
1	GND
2	A+
3	Α-
4	GND
5	B-
6	B+
7	GND

2-wire (+,-) for high-speed

SATA 1: 1.5Gb/s SATA 2: 3Gb/s

SATA 3: 6Gb/s

#### **USB:** Universal Serial Bus

#### Insert correctly

- USB 1.0 (12 Mbit/s) introduced in 1996
- USB 2.0 (480 Mbit/s) in 2000
- USB 3.0 (5 Gbit/s) in 2012
- USB-C 2016.
- USB 3.2 (30 Gbit/s) in July 20, 2017



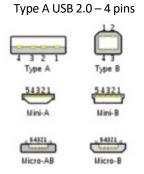
#### On third try

Credit: Reddit

. Ilaa adiffa waxatial bi diwaatia waxaa aa wada aa waxaa waxaatia wa

Created by Compaq, Digital, IBM, Intel, Northern Telecom and Microsoft.

Uses differential bi-direction serial communications

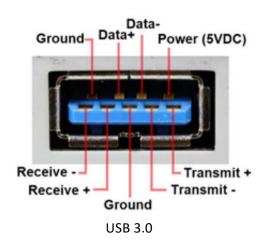


Pin	Name	Cable color	Description		
1	VCC	Red	+5 V		
2	D-	White	Data -		
3	D+	Green	Data +		
4	GND	Black	Ground		

Type A & B Pinout

Pin	Name	Color	Description
1	VCC	Red	+5 V
2	D-	White	Data -
3	D+	Green	Data +
4	ID	none	permits distinction of Micro-A- and Micro-B-Plug Type A: connected to Ground Type B: not connected
5	GND	Black	Signal Ground

Mini/Micro Pinout



#### **USB:** Universal Serial Bus

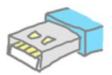
 More defined layers than your other things we've seen

The 2000 version of USB spec was 570 pages long

- Current USB 3.2 (9/22/2017 release!...so new! so fresh!)
  - spec is 103 MB zip file\*
  - Approximately 8,000 pages long at this point
  - I'll summarize in a few slides

From the well known fact that you have to spin the USB three times, the usb must have three states.

Up position



Down position



Superposition



Untill the USB are observed it will stay in the superposition. Therfor it will not fit untill observed. Exept for cases of USB tunneling.

<sup>\*</sup>and hosted on web page that has painfully slow DL speeds and looks like it is from 2000

## How is Data Transmitted in USB (High Level):

- Communication uses handshakes to establish capable/expected data rates
- Host device (computer for example), assigns connected devices temporary IDs on shared bus.
- Packets of information, including headers, payloads, and error checks (CRC5, CRC16, and CRC32 are used) are sent between host and client devices

## How is Data Transmitted in USB (Bit Level):

- USB uses twisted wire pairs and there is no CLOCK wire
- All data is transmitted using Non-Return-Zero-Inverted (NRZI) encoding:
  - A 0 is encoded as a value change
  - A 1 is encoded by no change
- After initial synchronization byte, the receiver extracts the clock from the on-average probability of 0's in the data (which give transitions) using local oscillator and Phase-Locked Loops
- Avoid long stretches of 1's by bit-stuffing (shoving 0's in to avoid periods of time where no transitions happen)...similar to ether protocols
- Capable of up to 30 Gbit/s
  - ~2 decent resolution movies per second

#### USB - C

- Universal connector for power and data first product MacBook Air one and only port!
- Symmetrical no orientation (Good for 10,000 insert/withdrawals...10 kiloinserts)
- Supports DisplayPort, HDMI, power, USB, and VGA. Uses differential bidirection serial communications
- Supplies up to 100W power (5V @ up to 2A, 12V @ up to 5A, and 20V @ up to 5A)
- Voltage dictated by software handshake, etc..
- New adapters required for DisplayPort, HDMI, power, USB, and VGA omg!

Figure 2-1 USB Type-C Receptacle Interface (Front View)

A1	A2	A3	A4	A5	A6	A7	A8	A9	A10	A11	A12
GND	TX1+	TX1-	Vaus	CC1	D+	D-	SBU1	Vaus	RX2-	RX2+	GND
GND	RX1+	RX1-	Vaus	SBU2	D-	D+	CC2	Vaus	TX2-	TX2+	GND
812	811	B10	89	88	87	86	85	84	B3	B2	81





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#### Potential Problems

- If we all followed the laws life would be grand
- Not everyone can read all 8,000 pages
- Not everyone wants to read all 8,000 pages
- Difference between 5V and 20V going into your laptop is now based on software handshakes between two devices.
- Do you trust your devices?
- Solution is now to do hardware verification prior to any power delivery using table of approveddevices for via 128 bit encryption (mid 2016)
- It'll be interesting to see how quickly this gets hacked





## Getting data back to the board...

### FTDI Chipsets

- Future Technology Devices International Ltd (FTDI) is a Scottish Electronics firm that makes USB interfaces
- They produce devices that convert between USB and:
  - UART
  - SPI
  - 12C
  - Parallel Out
- Extremely common

## The Great FTDI Bricking of 2014

- From the beginning of USB to only recently, most USB devices used FTDI-based chip sets to interface (source of those annoying FTDXX.h library issues you'd always see in Windows)
  - Your optical mouse would have some circuit and it would communicate internally with UART...then the FTDI chip would convert to USB
- Dozens of "clones" were built to work with that software, these clones often times selling for a small fraction of the cost of the original FTDI chips
- In 2014 FTDI they released a software update, included in most Windows Service Packs that bricked all "non-genuine" devices
- Turned out a lot of "legit" products were using counterfeits/clones

#### Human Interface Device (HID) Classes

- Complex, yet implementable communication protocol that utilizes widely accepted protocol:
- Have a device and/or FPGA directly run implement that part of the USB stack
- Can implement in ~10 state FSM or so
- Appear as a "mouse" or a "keyboard" or a "webcam", etc...
- Medium speeds...really need specialized hardware for the super speeds

#### RFID: Radio Frequency Identification

- Used to provide remote interrogation/identification
- Frequency bands:
  - 125 134 kHz [MIT ID]\*
  - 13.56 MHz [US Passports]
  - 400 960 MHz UHF
     [EZPASS 915mhz ~ 1 mw]\*\*
  - 2.45 GHz
  - 5.8 GHz

- \* excitation/broadcast powered
- \*\* battery powered

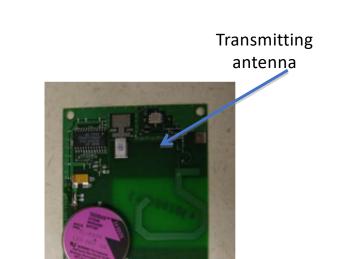
Legend

Contact smart chip module

125 kHz proximity antenna and chip



Like in MIT IDs:



Battery

EZ Pass Internals

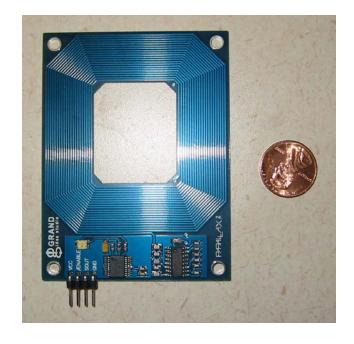
<sup>\*</sup>http://groups.csail.mit.edu/mac/classes/6.805/student-papers/fall04-papers/mit\_id/#specs

### 125khz RFID









125khz transmitter

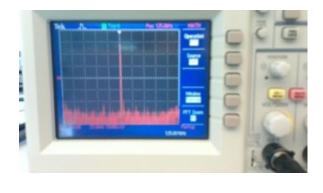
Receiver
Powered by 125khz broadcast signal

#### MIT RFID

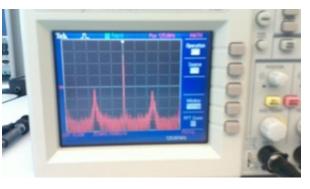
- 125 kHz carrier
- 62.5 kHz modulating wave phase-shifts every 16 cycles:
  - $\pi$  shift indicates a 1
  - No shift indicates a 0
- ...so we've got:
- Phase-shift-encoded Non-Return-to-Zero-Mark Encoding (NRZ-M)



Stimulating and Receiving Coils



FFT of Pickup on Receiving Coil while Stimulating Coil has 125 kHz driven into it and NO CARD in between (Spike is 125 kHz centered)



FFT of Pickup on Receiving Coil while Stimulating Coil has 125 kHz driven into it and CARD is in between (LOOK AT THAT SIDEBAND ACTION!!!)